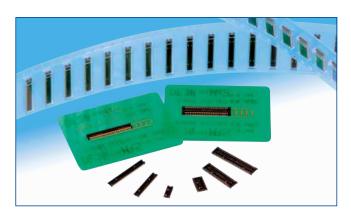
0.4 mm Pitch, 0.9 mm Height, Board-to-Board / Board-to-FPC Connectors

DF30 Series



Space-saving design Connector footprint is minimized. <40 contacts, mated> (0.90)Fig.1

Features

1. High-density mounting

This connector offers a space-saving design that reduces the connector footprint.

The low stacking height of 0.9 mm is highly suited for applications that require a low mounted height. (Fig.1)

2. High contact reliability

Projections on the header terminals increase the wiping ability and provide superior mating reliability. During mating, the projections of the header terminals produce a tactile click, which helps to confirm proper insertion. (Fig.2)

3. Self-alignment feature

A self-alignment range of 0.3 mm is provided on the receptacle and allows for easier mating in tight spaces. (Fig.3)

4. Wide selection of pin counts

Standard pin counts are 20, 22, 24, 30, 34, 40, 50, 60, 70, and 80 positions. Smaller pin counts are also available that are applicable to LCD and camera modules in cell phones.

In addition, reinforced types are available for each pin count model. (The external shape is the same for both standard and reinforced types.)

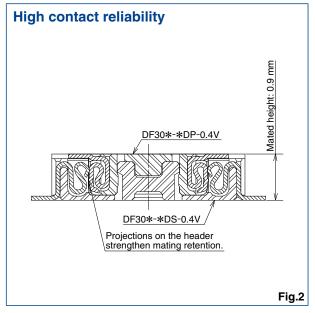
5. Suitable for automatic mounting

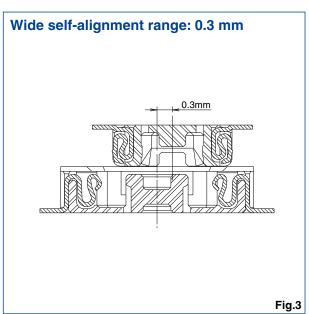
Although this connector is extremely small, it still has a sufficient vacuum area for pick-and-place machines to hold the part.

Receptacle area: 1.12 mm Header area: 1.11 mm

6. Test connectors

Highly durable test connectors are available which allow mounted production parts to be tested for electrical performance. Test connectors feature a higher number of insertions and removals cycles. These test connectors are for test purposes only and cannot be used for production requirements. For details, please contact your Hirose sales representative.





■Product Specifications

Rating	Rated curr	ent 0.3A	Operating temperature range :-35℃ to 85℃ (Note 1)			Storage temperature range	-10°C to 60°C (Note 2)		
Rated voltage 30V A		age 30V AC	Operating humidity range : Relative humidity 20% to 80		to 80%	Storage humidity range	Relative humidity 40% to 70% (Note 2)		
Item	l		Specification		Conditions				
1. Insulation re	esistance	50 MΩ min	l.		100V	/ DC			
2. Withstandin	ng voltage	No flashov	er or insulation break	down.	100V	AC / one minute			
3. Contact res	istance	100 mΩ m	ax.		100 r	mA			
4. Vibration		No electrical discontinuity of 1 we as many		Frequency: 10 to 55 Hz, single amplitude of					
4. VIDIALION		No electrical discontinuity of 1 μ s or more			0.75mm, 2 hours, 3 axis				
Con		Contact resistance: 100 mΩ max.			96 hours at temperature of 40°C±2°C and RH of				
5. Humidity Insulation resistance:		resistance: 25 MΩ mi	n. 90% to 95%						
0		cictonoo: 100 m0 ma	to made 100 mmO made		Temperature: $-55^{\circ}\text{C} \rightarrow +5^{\circ}\text{C}$ to $+35^{\circ}\text{C} \rightarrow +85^{\circ}\text{C} \rightarrow +5^{\circ}\text{C}$ to $+35^{\circ}\text{C}$				
6. Temperatur	re cycle	Contact resistance: 100 mΩ max. Insulation resistance: 50 MΩ min.		Duration: 30→10→30→10(Minutes)					
	msulation resistance. 50 Miz min.		11.	5 cycles					
7. Durability	7. Durability		50 cycles						
(insertions/w	ithdrawals)	Contact resistance. Too mix max.		Contact resistance: 100 mΩ max. (Connector for conductivity tests: 500				vity tests: 500 cycles)	
8. Resistance	to	No deformation of components affecting			Reflow: At the recommended temperature profi				
soldering he	eat	performan	performance.			Manual soldering: 350°C for 3 seconds			

Note 1: Includes temperature rise caused by current flow.

Note 2: The term "storage" refers to products stored for long period of time prior to mounting and use. Operating temperature range and humidity range covers non-conducting condition of installed connectors in storage, shipment or during transportation.

■ Materials

Connectors	Component	Material	Finish	Remarks
Receptacles	Insulator	LCP	Color : Black	UL94V-0
and	Contacts	Phosphor bronze	Gold plated	
Headers	Metal fittings	Phosphor bronze	Tin plated	

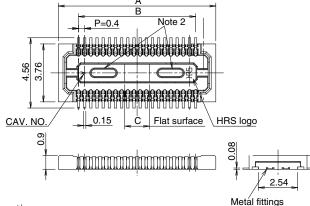
■Product Number Structure

Receptacles and Headers

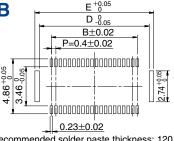
①Series name: DF30	5Contact pitch: 0.4 mm
2Configuration	6Termination section
FB/RB: With metal fittings, without bosses	V: Straight SMT
FC/RC: Without metal fittings, without bosses	Packaging
CJ: Connector for conductivity tests	(81): Embossed tape packaging (5,000 pcs/reel)
3Number of contacts: 20, 22, 24, 30, 34, 40, 50, 60, 70, 80	(82): Embossed tape packaging (1,000 pcs/reel)
4Connector type	
DS: Double row receptacle	
DP: Double row header	

■ Receptacles (with metal fittings)





Recommended PCB mounting pattern



[Specification number] -**, (**)

- (81): Embossed tape packaging (5,000 pcs/reel)
- (82): Embossed tape packaging (1,000 pcs/reel)

Recommended solder paste thickness: 120 μ m

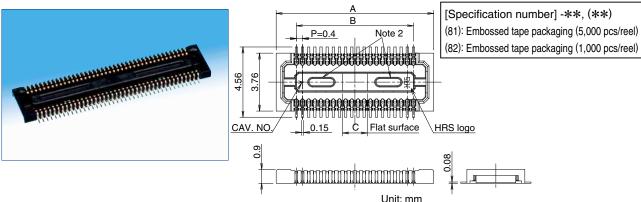
Unit: mm

								O
Part No.	HRS No.	No. of contacts	Α	В	С	D	Е	RoHS
DF30FB-20DS-0.4V(**)	684-1098-3 **	20	6.22	3.6		5.72	6.52	
DF30FB-22DS-0.4V(**)	684-1099-6 **	22	6.62	4.0	1.2	6.12	6.92	
DF30FB-24DS-0.4V(**)	684-1100-3 **	24	7.02	4.4	1.2	6.52	7.32	
DF30FB-30DS-0.4V(**)	684-1101-6 **	30	8.22	5.6		7.72	8.52	
DF30FB-34DS-0.4V(**)	684-1102-9 **	34	9.02	6.4	1.36	8.52	9.32	Yes
DF30FB-40DS-0.4V(**)	684-1103-1 **	40	10.22	7.6	1.6	9.72	10.52	165
DF30FB-50DS-0.4V(**)	684-1104-4 **	50	12.22	9.6	2.0	11.72	12.52	
DF30FB-60DS-0.4V(**)	684-1105-7 **	60	14.22	11.6	2.4	13.72	14.52	
DF30FB-70DS-0.4V(**)	684-1106-0 **	70	16.22	13.6	2.8	15.72	16.52	
DF30FB-80DS-0.4V(**)	684-1107-2 **	80	18.22	15.6	3.2	17.72	18.52	

Note 1: Order by number of reels.

Note 2: Receptacles with 24 or fewer contacts positions will not have recessed areas.

■Receptacles (without metal fittings)

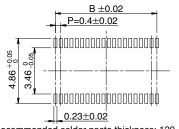


						· · · · · · · · · · · · · · · · · · ·
Part No.	HRS No.	No. of contacts	Α	В	С	RoHS
DF30FC-20DS-0.4V(**)	684-1109-8 **	20	6.22	3.6		
DF30FC-22DS-0.4V(**)	684-1110-7 **	22	6.62	4.0	1.2	
DF30FC-24DS-0.4V(**)	684-1111-0 **	24	7.02	4.4	1.2	
DF30FC-30DS-0.4V(**)	684-1112-2 **	30	8.22	5.6		
DF30FC-34DS-0.4V(**)	684-1113-5 **	34	9.02	6.4	1.36	Yes
DF30FC-40DS-0.4V(**)	684-1078-6 **	40	10.22	7.6	1.6	res
DF30FC-50DS-0.4V(**)	684-1114-8 **	50	12.22	9.6	2.0	
DF30FC-60DS-0.4V(**)	684-1082-3 **	60	14.22	11.6	2.4	
DF30FC-70DS-0.4V(**)	684-1115-0 **	70	16.22	13.6	2.8	
DF30FC-80DS-0.4V(**)	684-1116-3 **	80	18.22	15.6	3.2	

Note 1: Order by number of reels.

Note 2: Receptacles with 24 or fewer contacts positions will not have recessed areas.

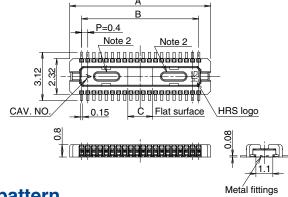
◆ Recommended PCB mounting pattern



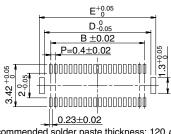
Recommended solder paste thickness: 120 μ m

■Header (with metal fittings)





◆Recommended PCB mounting pattern



[Specification number -**, (**)

(81): Embossed tape packaging (5,000 pcs/reel)

(82): Embossed tape packaging (1,000 pcs/reel)

Recommended solder paste thickness: 120 μ m

Unit: mm

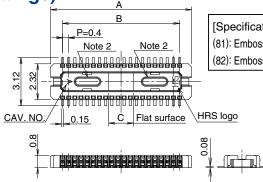
Part No.	HRS No.	No. of contacts	Α	В	С	D	Е	RoHS
DF30RB-20DP-0.4V(**)	684-1279-8 **	20	5.14	3.6		4.64	5.44	
DF30RB-22DP-0.4V(**)	684-1280-7 **	22	5.54	4.0	1.2	5.04	5.84	
DF30RB-24DP-0.4V(**)	684-1281-0 **	24	5.94	4.4	1.2	5.44	6.24	
DF30RB-30DP-0.4V(**)	684-1282-2 **	30	7.14	5.6		6.64	7.44	
DF30RB-34DP-0.4V(**)	684-1283-5 **	34	7.94	6.4	1.36	7.44	8.24	Yes
DF30RB-40DP-0.4V(**)	684-1284-8 **	40	9.14	7.6	1.6	8.64	9.44	res
DF30RB-50DP-0.4V(**)	684-1286-3 **	50	11.14	9.6	2.0	10.64	11.44	
DF30RB-60DP-0.4V(**)	684-1287-6 **	60	13.14	11.6	2.4	12.64	13.44	
DF30FB-70DP-0.4V(**)	684-1075-8 **	70	15.14	13.6	2.8	14.64	15.44	
DF30FB-80DP-0.4V(**)	684-1136-0 **	80	17.14	15.6	3.2	16.64	17.44	

Note 1: Order by number of reels.

Note 2: Headers with 24 or fewer contacts positions will not have protruding areas.

■Header (without metal fittings)





[Specification number] -**, (**)

(81): Embossed tape packaging (5,000 pcs/reel)

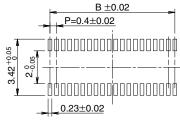
(82): Embossed tape packaging (1,000 pcs/reel)

Unit: mm

Part No.	HRS No.	No. of contacts	Α	В	O	RoHS
DF30RC-20DP-0.4V(**)	684-1268-1 **	20	5.14	3.6		
DF30RC-22DP-0.4V(**)	684-1269-4 **	22	5.54	4.0	1.2	
DF30RC-24DP-0.4V(**)	684-1270-3 **	24	5.94	4.4	1.2	
DF30RC-30DP-0.4V(**)	684-1271-6 **	30	7.14	5.6		
DF30RC-34DP-0.4V(**)	684-1272-9 **	34	7.94	6.4	1.36	Yes
DF30RC-40DP-0.4V(**)	684-1273-1 **	40	9.14	7.6	1.6	res
DF30RC-50DP-0.4V(**)	684-1275-7 **	50	11.14	9.6	2.0	
DF30RC-60DP-0.4V(**)	684-1276-0 **	60	13.14	11.6	2.4	
DF30FC-70DP-0.4V(**)	684-1077-3 **	70	15.14	13.6	2.8	
DF30FC-80DP-0.4V(**)	684-1144-9 **	80	17.14	15.6	3.2	

Note 1: Order by number of reels.

Recommended PCB mounting pattern



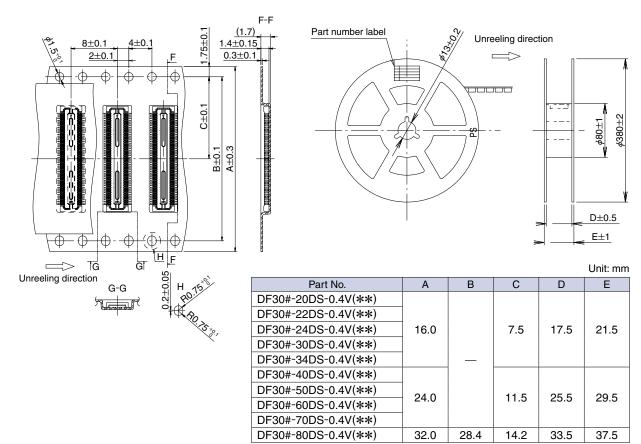
Recommended solder paste thickness: 120 μ m

Note 2: Receptacles with 24 or fewer contacts positions will not have recessed areas.

◆ Packaging Specification

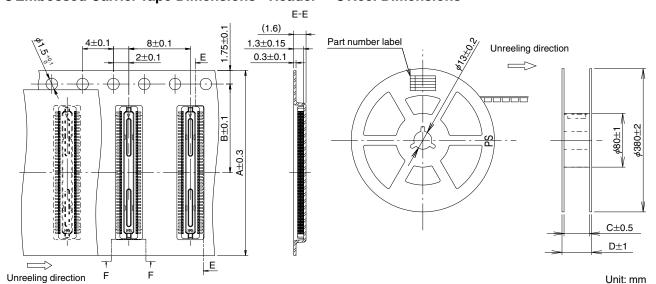
● Embossed Carrier Tape Dimensions - Receptacle

Reel Dimensions



Embossed tape 32mm or wider will have perforated feed holes on two sides.

●Embossed Carrier Tape Dimensions - Header Reel Dimensions



Part No. Α В DF30#-20DP-0.4V(**) DF30#-22DP-0.4V(**) DE00# 04DD 0 41/4mh

DF30#-24DP-0.4V(**)	16.0	7.5	17.5	21.5
DF30#-30DP-0.4V(**)	10.0	7.5	17.5	21.0
DF30#-34DP-0.4V(**)				
DF30#-40DP-0.4V(**)				
DF30#-50DP-0.4V(**)				
DF30#-60DP-0.4V(**)	24.0	11.5	25.5	29.5
DF30#-70DP-0.4V(**)	24.0	11.5	25.5	29.5
DF30#-80DP-0.4V(**)				

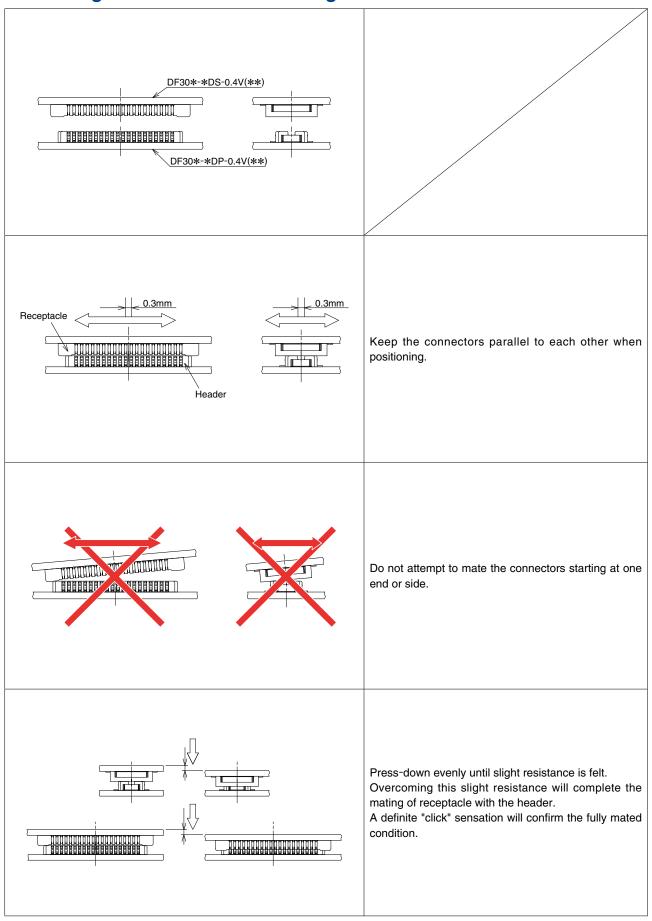
D

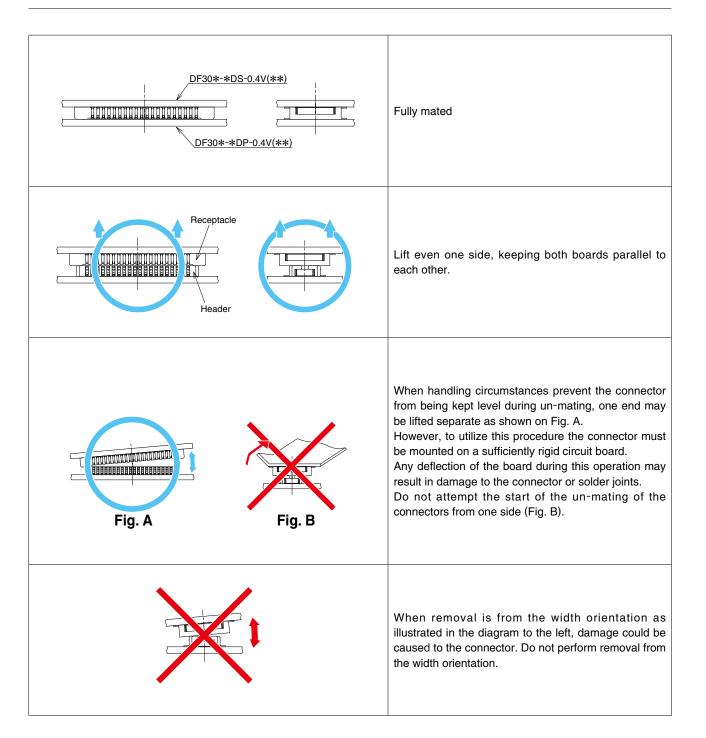
С

● Usage Recommendations

1 Recommended temperature	
Recommended temperature	Ordinary solder cream
profile	<u>ي</u> 250 240
	220
	<u>a</u> 200
	10 to 20 sec. Soldering
	150 (60 to 90 sec.
	Preheating
	100/
	7
	Time (seconds)
	● Lead-free solder cream
	10 seconds or less
	250
	<u>a</u> 200
	60 seconds or less
	150 Soldering 150
	Preheating
	100/
	√
	Time (seconds)
	Note 1. Up to 0 evalor of Deflow coldering are possible under the same conditions are vided that there is a
	Note 1: Up to 2 cycles of Reflow soldering are possible under the same conditions, provided that there is a return to normal temperature between the first and second cycle.
	Note 2: The temperature profile indicates the board surface temperature at the point of contacts with the
	connector terminals.
2. Recommended manual soldering	Manual soldering: 340±10℃ for 3 seconds
3. Recommended screen thickness	Thickness: 0.12 mm
and open area ratio	Opening are ratio: DS side 100%, DP side 84%
(Pattern area ratio)	
4. Board warpage	Maximum of 0.02 mm at the connector center, with both ends of the connector as
E Cleaning conditions	reference points.
Cleaning conditions Precautions	Please refer to the "Handbook on the Use of Wire-to-Board Connectors". ■ Terminals are exposed on the header side. Please note that touching them with bare
	hands causes contact failure or static electricity, resulting in damage to the components.
	■ Note that mating/unmating when the product is not mounted on the PCB could cause
	damage or deformation of the terminal.
	Avoid supporting the PCB using only the connectors. Other means of support are
	needed.
	■ Care should be taken that excessive prying during mating/unmating could cause
	damage.
	■ In the case of hand soldering, please do not apply any flux, which could cause flux
	wicking.
	■ The product may differ slightly in color due to different production lots of the resin. This
	color variation has no influence on the performance.
	■ Please refer to the next page for the precautions for mating/unmating.
	■ Care should be taken to secure the mated connector and FPC within the device with
	housings and cushioning materials. This will help prevent disconnections or unmating in
	the event of dropping, other external forces or stressed routing of the FPC.

● Handling Precautions when mating the connectors







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